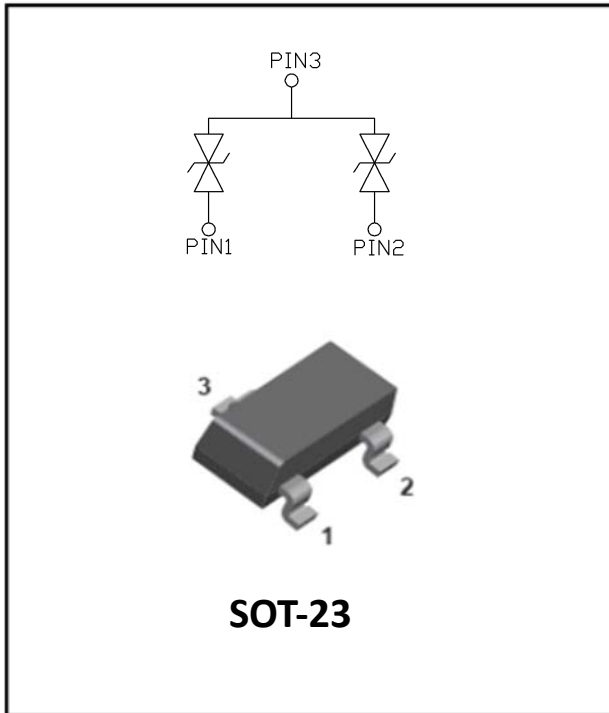


2-Line, Bi-directional, Transient Voltage Suppressor



Features

- Stand-off voltage: $\pm 24V$ Max
- Transient protection for each line according to
IEC61000-4-2(ESD): $\pm 30kV$ (contact)
IEC61000-4-5(surge): 8A (8/20 μs)
- Low leakage current:
- Ultra low clamping voltage
- RoHS Compliant

Applications

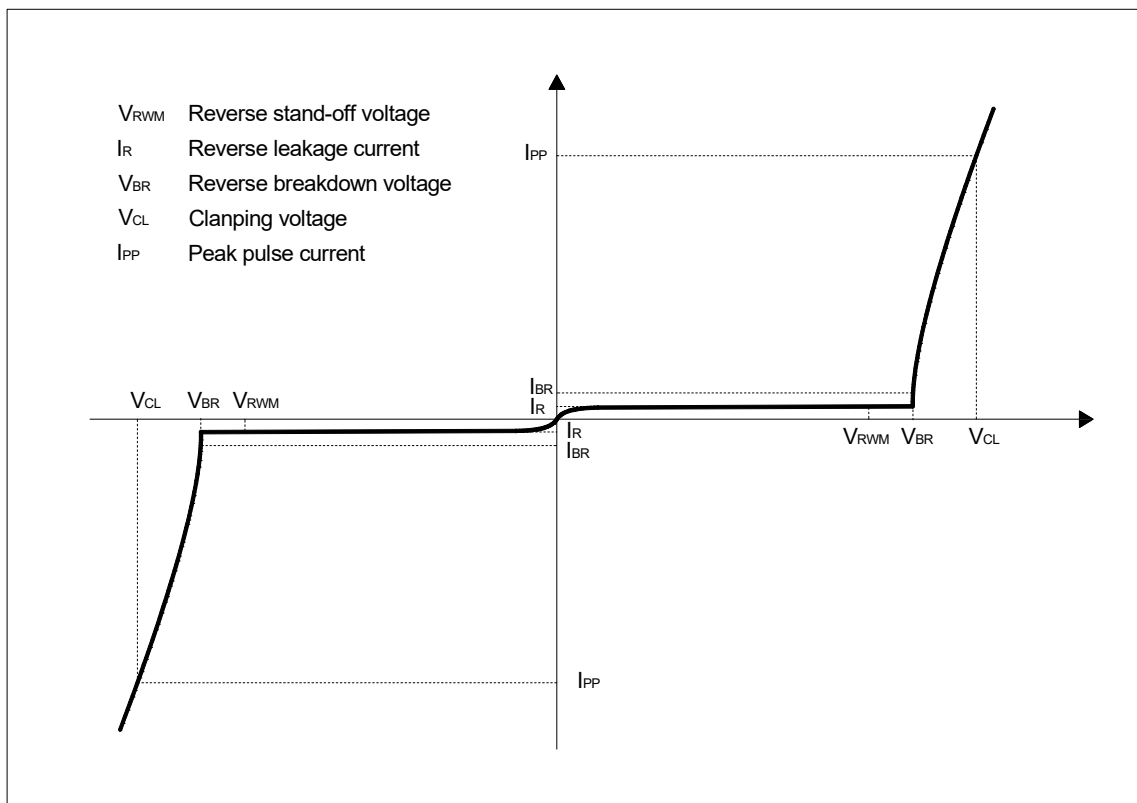
- Cellular Handsets and Accessories
- Notebooks and Handhelds
- Portable Instrumentation
- Set Top Box
- Industrial Controls
- Server and Desktop PC

Mechanical Data

- Package: SOT-23
- Lead Finish: Matte Tin
- Case Material: "Green" Molding Compound
- Moisture Sensitivity: Level 1 per J-STD-020
- Marking Information: See Below



■Definitions of electrical characteristics





ESD2402EB

■Maximum Ratings

PARAMETER	SYMBOL	LIMITS	UNIT
Peak pulse power ($t_p = 8/20\mu s$)	P_{pk}	350	W
Peak pulse current ($t_p = 8/20\mu s$)	I_{PP}	8	A
ESD according to IEC61000-4-2 air discharge	V_{ESD}	± 30	KV
ESD according to IEC61000-4-2 contact discharge		± 30	
Junction temperature	T_J	125	$^{\circ}C$
Storage temperature	T_{STG}	-55~150	$^{\circ}C$

■Electrical Characteristics ($T_a=25^{\circ}C$ Unless otherwise specified)

PARAMETER	Symbol	UNIT	Conditions	Min	Typ	Max
Reverse maximum working voltage	V_{RWM}	V				± 24
Reverse leakage current	I_R	μA	$V_{RWM} = 24V$			0.5
Reverse breakdown voltage	V_{BR}	V	$I_T = 1mA$	26.3		31
Clamping voltage ¹⁾	V_{CL}	V	$I_{PP} = 1A, t_p = 8/20\mu s$			34
		V	$I_{PP} = 5A, t_p = 8/20\mu s$		34	40
		V	$I_{PP} = 8A, t_p = 8/20\mu s$		38	44
Junction capacitance	C_J	pF	$V_R = 0V, f = 1MHz$		27	30

Notes:

(1). Non-repetitive current pulse, according to IEC61000-4-5.

■Ordering Information (Example)

PREFERRED P/N	PACKING CODE	UNIT WEIGHT(mg)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
ESD2402EB	F2	Approximate 8	3000	30000	120000	7" reel



■ Characteristics (Typical)

Fig.1 8/20μs waveform per IEC61000-4-5

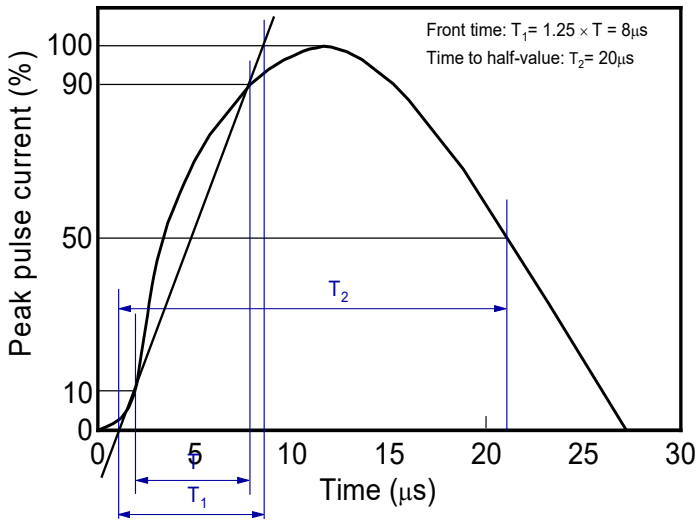


Fig.2 Contact discharge current waveform per IEC61000-4-2

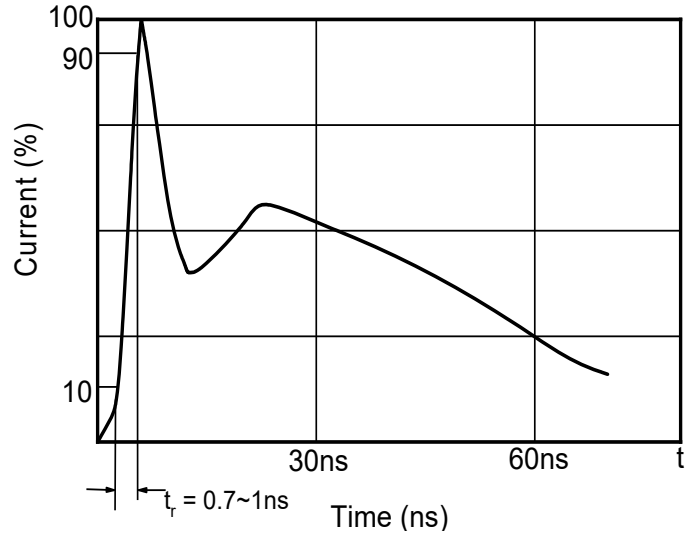


Fig.3 Clamping voltage vs. Peak pulse current

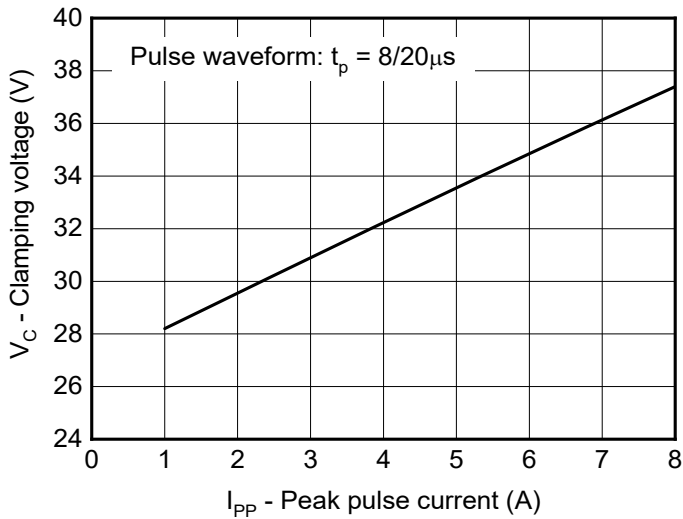


Fig.4 Capacitance vs. Reverse voltage

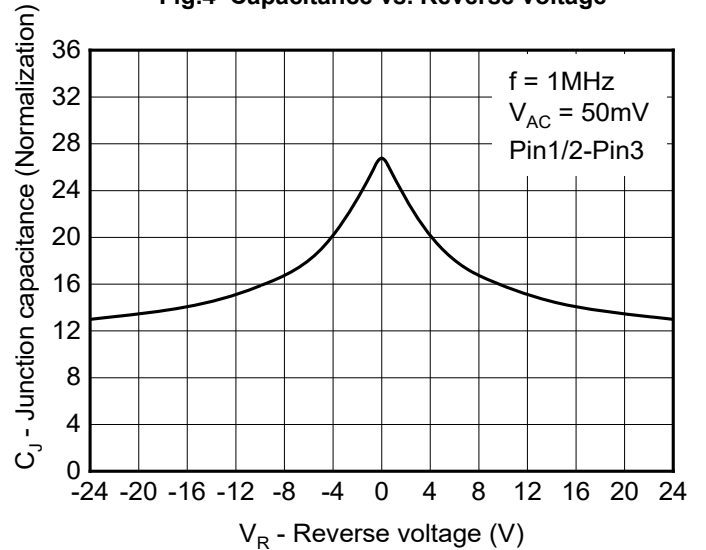


Fig.5 Non-repetitive peak pulse power vs. Pulse time

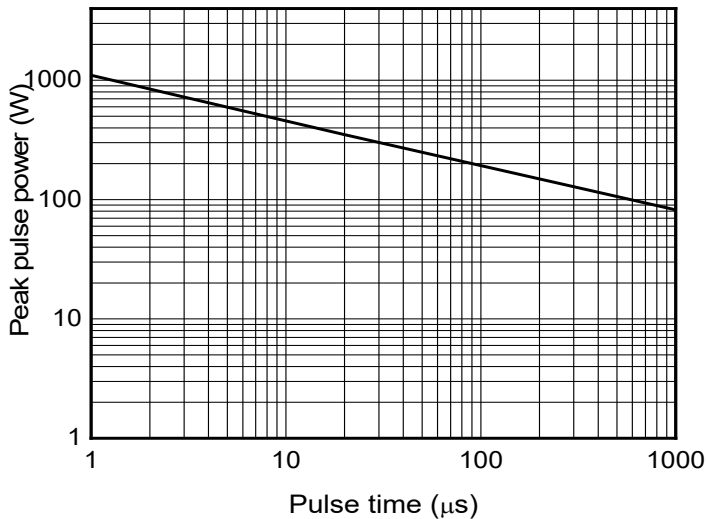
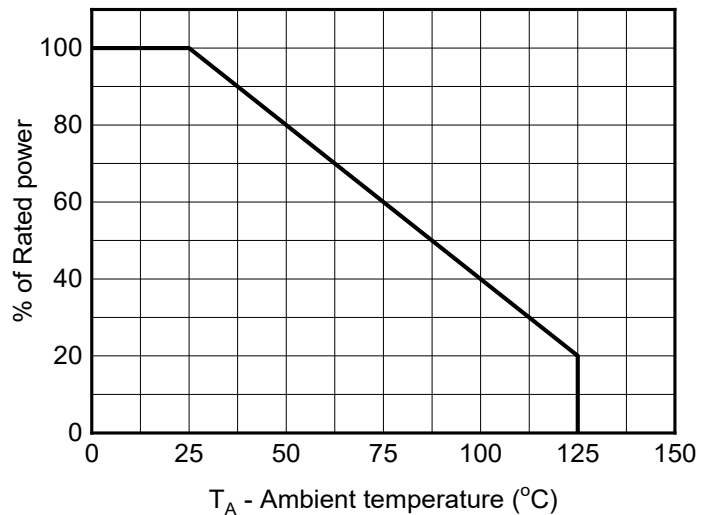


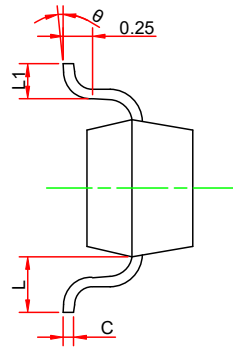
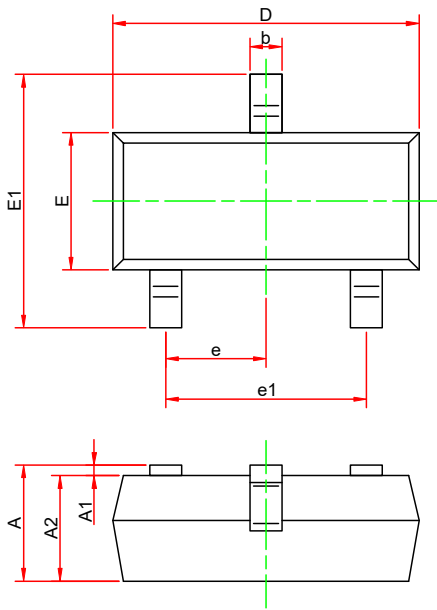
Fig.6 Power derating vs. Ambient temperature





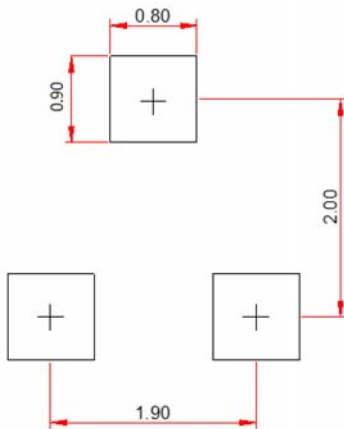
ESD2402EB

■ Outline Dimensions



Symbol	Dimensions in millimeters		
	Min.	Typ.	Max.
A	0.900	-	1.150
A1	0.000	-	0.100
A2	0.900	-	1.050
b	0.300	-	0.500
c	0.100	-	0.200
D	2.800	-	3.000
E	1.200	-	1.400
E1	2.250	-	2.550
e	0.950TYP		
e1	1.800	-	2.000
L	0.550REF		
L1	0.300	-	0.500
θ	0°	-	8°

■ Soldering Footprint





ESD2402EB

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